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TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π -MOSVI)

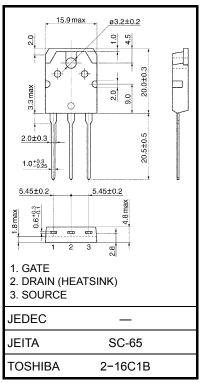
2SK3904

Switching Regulator Applications

- Low drain-source ON resistance: $RDS(ON) = 0.2 \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 9.5 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 100 \ \mu A (max) (V_{DS} = 450 \ V)$
- Enhancement model: $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{ID} = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	450	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V _{DGR}	450	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	۱ _D	19	А	
	Pulse (Note 1)	I _{DP}	76	~	
Drain power dissipation (Tc = 25° C)		PD	150	W	
Single pulse avalanche energy (Note 2)		E _{AS}	820	mJ	
Avalanche current		I _{AR}	19	А	
Repetitive avalanche energy (Note 3)		E _{AR}	15	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Thermal Characteristics

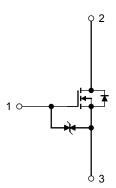
Characteristic	Symbol	Max	Unit	
Thermal resistance, channel to case	R _{th (ch-c)}	0.833	°C/W	
Thermal resistance, channel to ambient	R _{th (ch-a)}	50	°C/W	

Note 1: Ensure that the channel temperature does not exceed 150°C during use of the device.

Note 2: $V_{DD} = 90 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}, \text{ L} = 3.79 \text{ mH}, \text{ R}_{G} = 25 \Omega, \text{ I}_{AR} = 19 \text{ A}$

Note 3: Repetitive rating: pulse width limited by max junction temperature

This transistor is an electrostatic-sensitive device. Handle with care.



Unit: mm

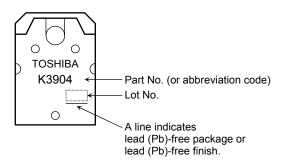
Electrical Characteristics (Ta = 25°C)

Char	acteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm 25~V,~V_{DS}=0~V$			±10	μA
Drain-source bre	akdown voltage	V (BR) GSS	$I_G=\pm 10~\mu\text{A},~V_{DS}=0~\text{V}$	±30	_	_	V
Drain cut-off curr	ent	I _{DSS}	$V_{DS} = 450 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_	_	100	μA
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	450	_	_	V
Gate threshold ve	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	2.0	_	4.0	V
Drain-source ON	resistance	R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}$	_	0.2	0.26	Ω
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}$	2.6	9.5	_	S
Input capacitance	9	C _{iss}		_	3100	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	_	20	_	pF
Output capacitance		C _{oss}			270		
Switching time	Rise time	tr	$V_{GS}^{10 \text{ V}} \downarrow \downarrow$		70	_	
	Turn-on time	t _{on}		_	130		
	Fall time	t _f		_	70		ns
	Turn-off time	t _{off}		_	280	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq 360 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 19 \text{ A}$	_	62		nC
Gate-source charge		Q _{gs}		_	40	—	
Gate-drain ("Miller") charge		Q _{gd}			22		

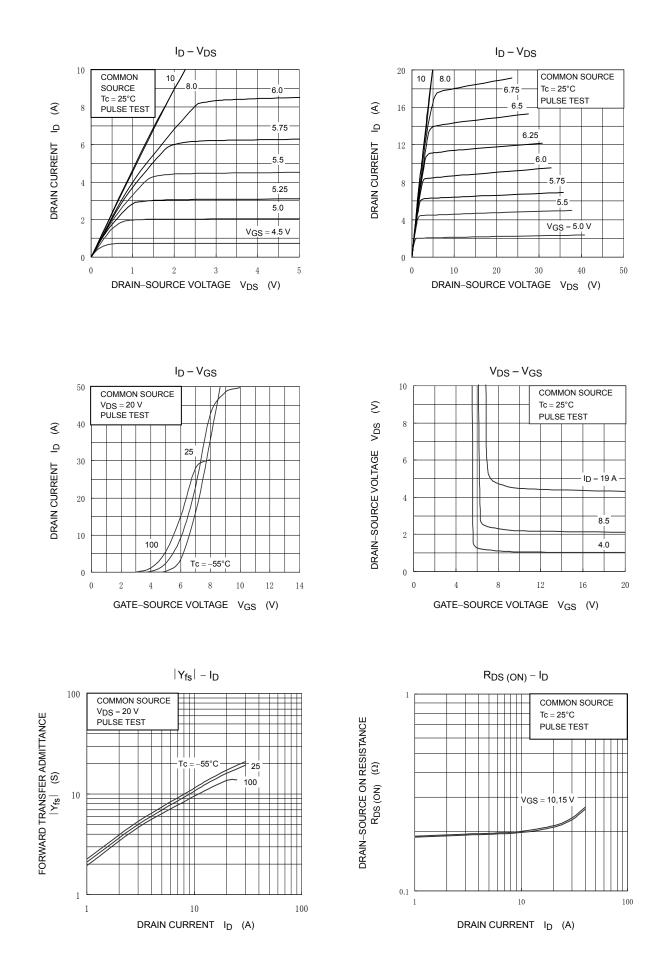
Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	_	19	А
Pulse drain reverse current (Note 1)	I _{DRP}	—	_	_	76	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 19 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 19 A, V _{GS} = 0 V,	_	1300	_	μS
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/μs	_	18	_	μC

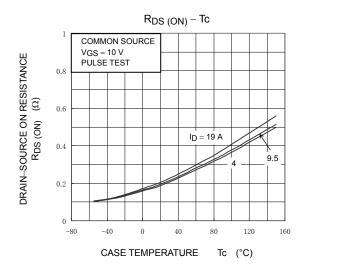
Marking

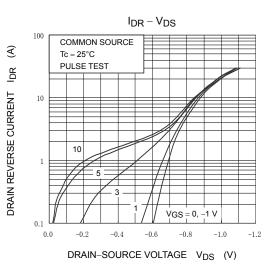


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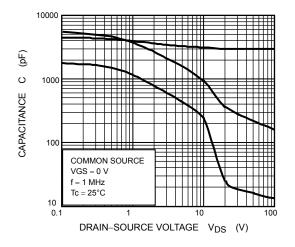


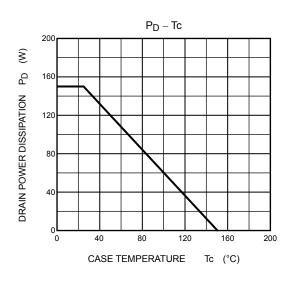
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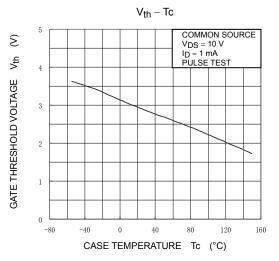




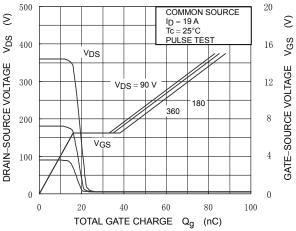
CAPACITANCE - VDS

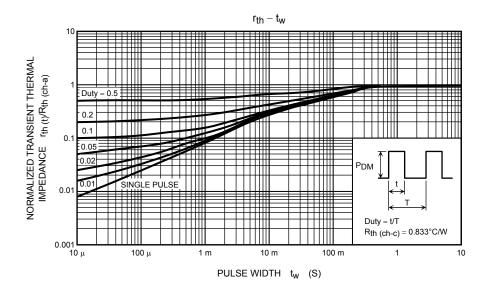




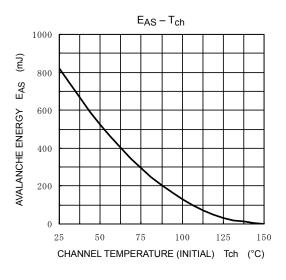


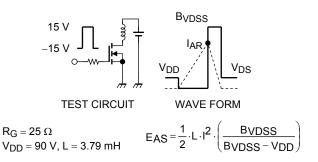






SAFE OPERATING AREA 100 ID max (PULSED) 11111 100 μs E 10DRAIN CURRENT ID ID max (CONTINUOUS) 1 OPERATION Tc = 25°C DC 0.1 SINGLE NONPETITIVE PULSE $\text{Tc}=25^{\circ}\text{C}$ Curves must be derated linearly with VDSS ma increase in temperature. 0.01 10 100 1000 1 DRAIN-SOURCE VOLTAGE VDS (V)





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